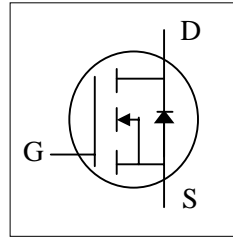




- ▼ Simple Drive Requirement
- ▼ SO-8 Compatible with Heatsink
- ▼ Low On-resistance
- ▼ RoHS Compliant & Halogen-Free

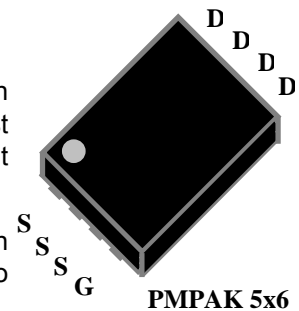


BV_{DSS}	30V
$R_{DS(ON)}$	3.3m Ω
I_D^5	105A

Description

AP3R303 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The PMPAK[®] 5x6 ppackage is special for voltage conversion application using standard infrared reflow technique with the backside heat sink to achieve the good thermal performance.



Absolute Maximum Ratings @ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	+20	V
$I_D@T_C=25^\circ\text{C}$	Drain Current (Chip), $V_{GS} @ 10V^5$	105	A
$I_D@T_A=25^\circ\text{C}$	Drain Current ³ , $V_{GS} @ 10V$	31	A
$I_D@T_A=70^\circ\text{C}$	Drain Current ³ , $V_{GS} @ 10V$	25	A
I_{DM}	Pulsed Drain Current ¹	250	A
$P_D@T_C=25^\circ\text{C}$	Total Power Dissipation	56.8	W
$P_D@T_A=25^\circ\text{C}$	Total Power Dissipation	5	W
E_{AS}	Single Pulse Avalanche Energy ⁴	28.8	mJ
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	2.2	$^\circ\text{C}/\text{W}$
Rthj-a	Maximum Thermal Resistance, Junction-ambient ³	25	$^\circ\text{C}/\text{W}$



AP3R303GMT-HF

Electrical Characteristics @ $T_j=25^{\circ}\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10V, I_D=30A$	-	-	3.3	m Ω
		$V_{GS}=4.5V, I_D=20A$	-	-	4.5	m Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	-	3	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=20A$	-	60	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=24V, V_{GS}=0V$	-	-	10	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Q_g	Total Gate Charge	$I_D=30A$	-	13.3	21	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=15V$	-	2.5		nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=4.5V$	-	7.2		nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=15V$	-	8	-	ns
t_r	Rise Time	$I_D=1A$	-	5.5	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega$	-	25	-	ns
t_f	Fall Time	$V_{GS}=10V$	-	17	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	1400	2240	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	440	-	pF
C_{riss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	170	-	pF
R_g	Gate Resistance	$f=1.0\text{MHz}$	-	1.4	2.8	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=30A, V_{GS}=0V$	-	-	1.2	V
t_{rr}	Reverse Recovery Time	$I_S=10A, V_{GS}=0V,$	-	35	-	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100A/\mu s$	-	32	-	nC

Notes:

1. Pulse width limited by Max. junction temperature
2. Pulse test
3. Surface mounted on 1 in² copper pad of FR4 board, $t \leq 10\text{sec}$; 60°C/W at steady state.
4. Starting $T_j=25^{\circ}\text{C}$, $V_{DD}=25V$, $L=0.1\text{mH}$, $R_G=25\Omega$, $I_{AS}=24A$.
5. Package limitation current is 60A .

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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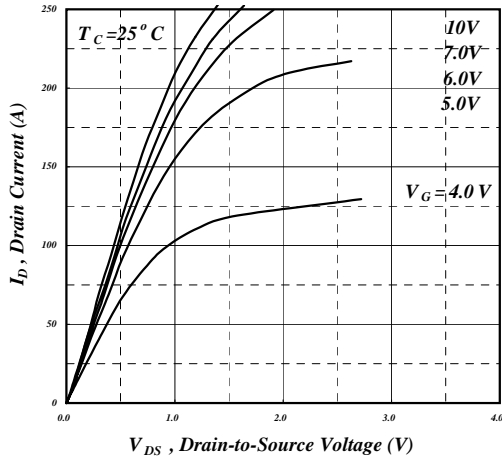


Fig 1. Typical Output Characteristics

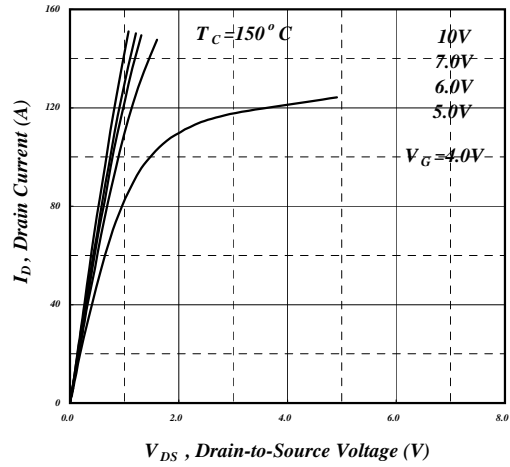


Fig 2. Typical Output Characteristics

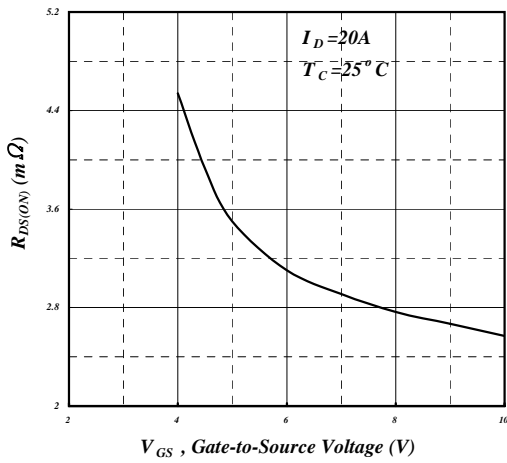


Fig 3. On-Resistance v.s. Gate Voltage

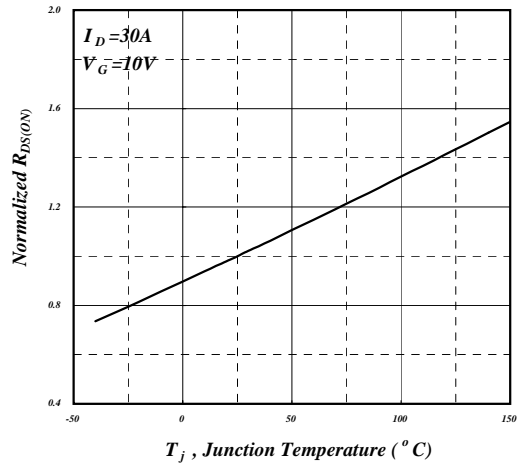


Fig 4. Normalized On-Resistance v.s. Junction Temperature

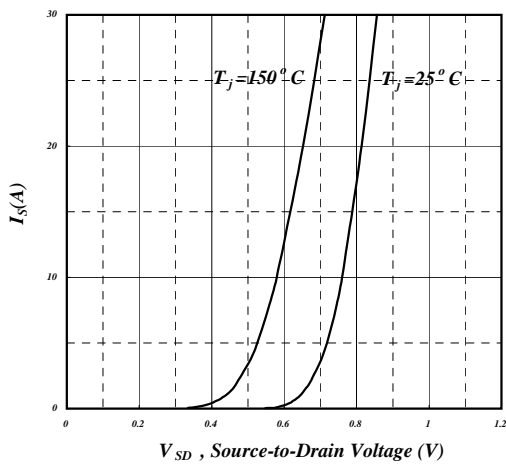


Fig 5. Forward Characteristic of Reverse Diode

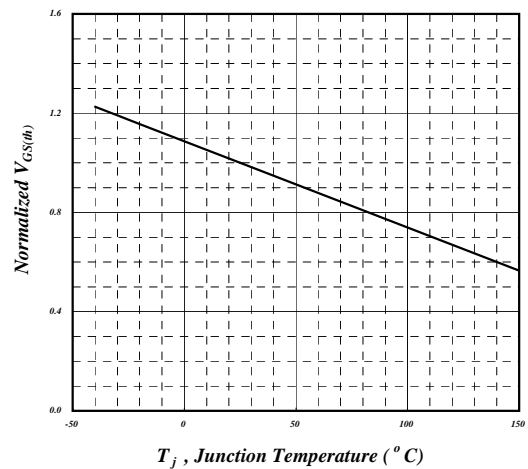


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

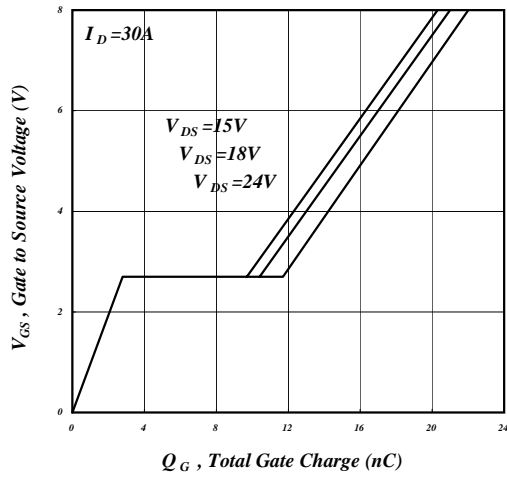


Fig 7. Gate Charge Characteristics

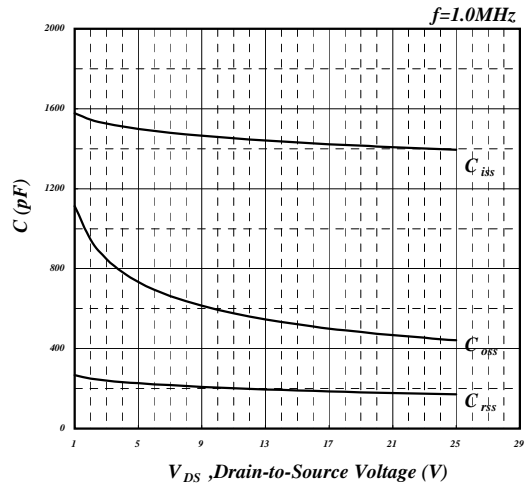


Fig 8. Typical Capacitance Characteristics

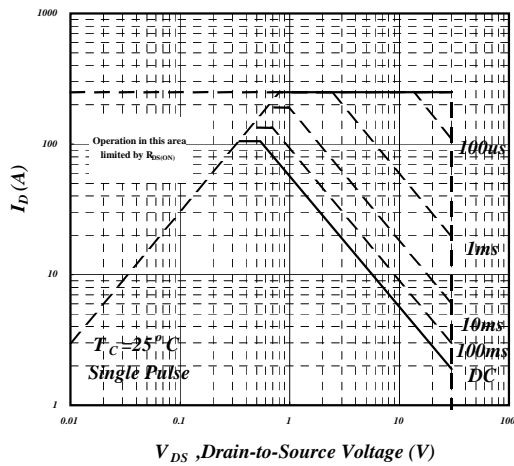


Fig 9. Maximum Safe Operating Area

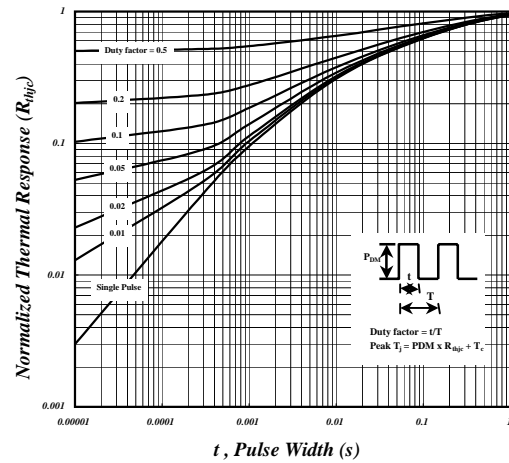


Fig 10. Effective Transient Thermal Impedance



Fig 11. Switching Time Waveform

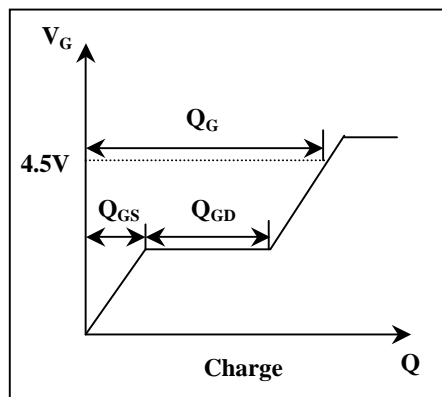
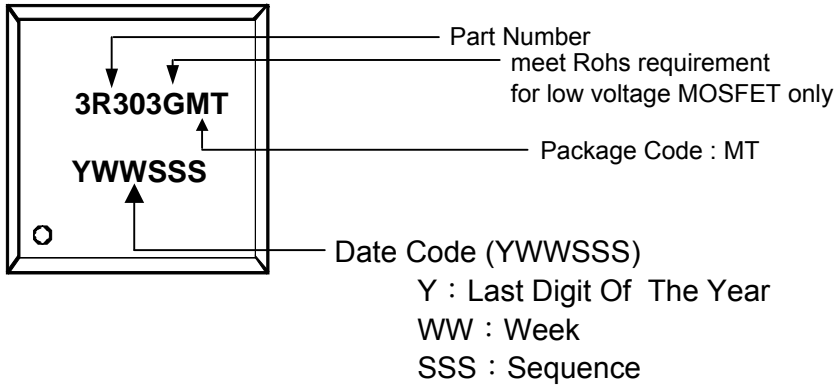


Fig 12. Gate Charge Waveform

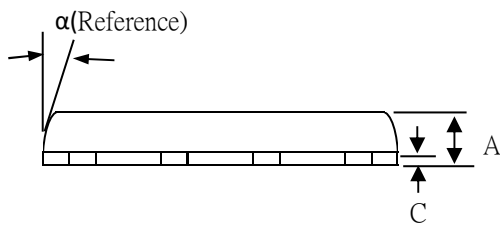
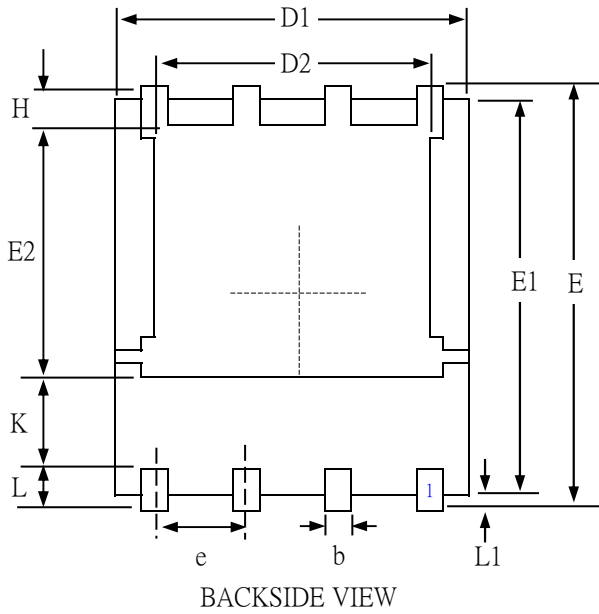


MARKING INFORMATION





Package Outline : PMPAK 5x6

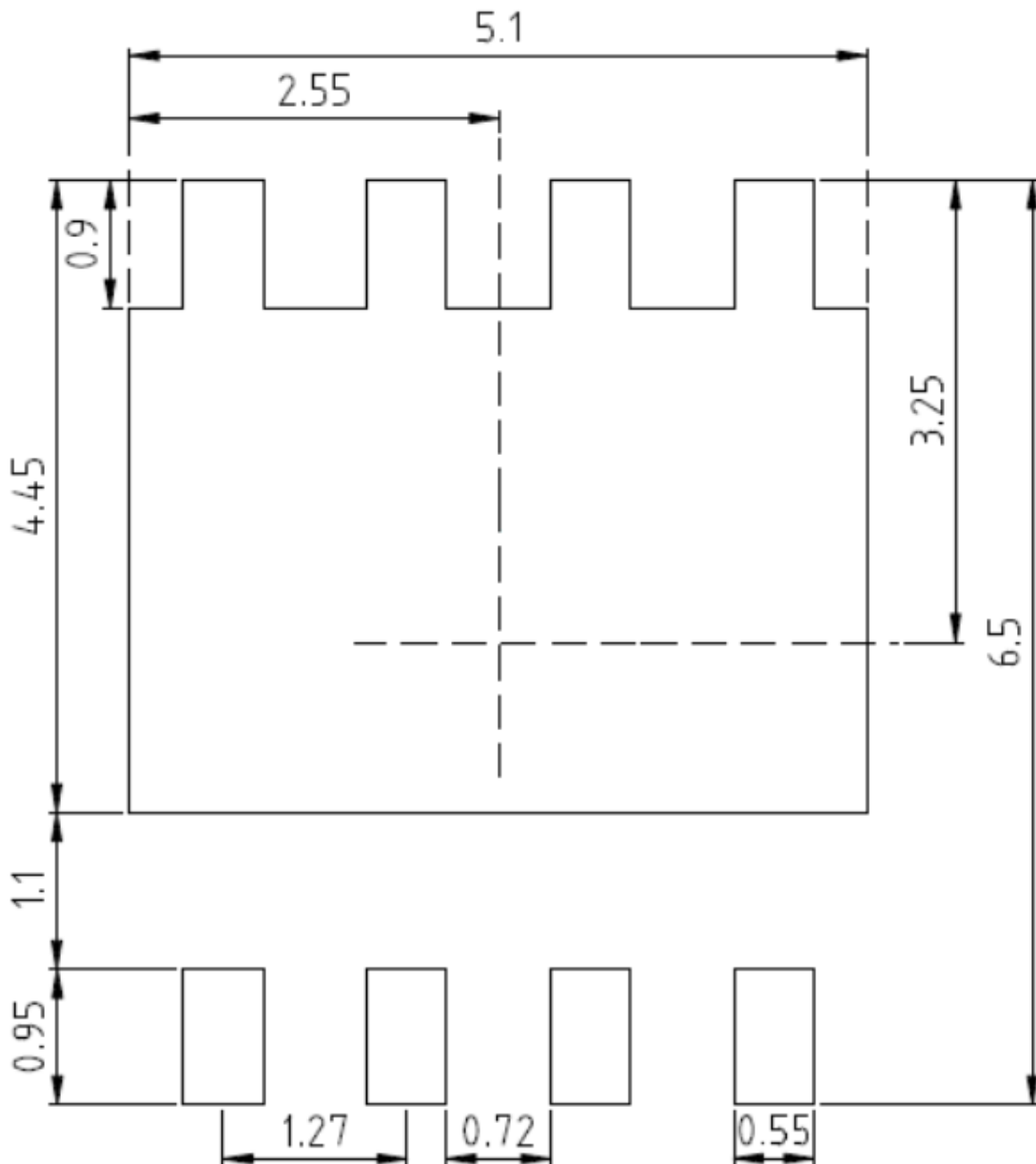


SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	0.90	1.10	1.30
b	0.33	0.41	0.51
C	0.254(Ref.)		
D1	4.80	4.90	5.10
D2	3.61	4.00	4.40
E	5.80	6.03	6.25
E1 (Ref.)	5.60	5.75	5.90
E2 (Ref.)	3.30	3.55	3.80
e	1.27 BSC		
H	0.35	—	0.90
K (Ref.)	1.00	1.275	—
L	0.35	0.55	0.75
L1	0.06	0.13	0.20
α (Ref.)	0°	—	12°

- 1.All dimension are in millimeters.
- 2.Dimension does not include burrs and mold flash/protrusions.
- 3.The outline schematic is not to scale and slightly different from the actual product appearance.



PMPAK 5X6(E-TYPE) FOOTPRINT :



UNIT: mm

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